

1:8 LOW JITTER CMOS CLOCK BUFFER (<200 MHz)

Features

- 8 LVCMOS outputs
- Ultra-low additive jitter: 150 fs rms
- Wide frequency range: 1 to 200 MHz
- Asynchronous output enable
- Low output-output skew: <150 ps
- Low propagation delay variation: <400 ps
- RoHS compliant, Pb-free
- Industrial temperature range: -40 to +85 °C
- Footprint-compatible with CDCLVC1108
- 1.8, 2.5, or 3.3 V operation
- 16-TSSOP

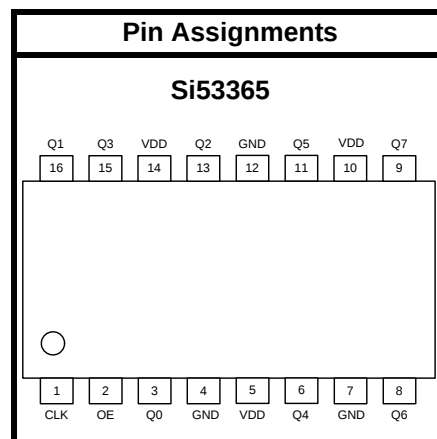
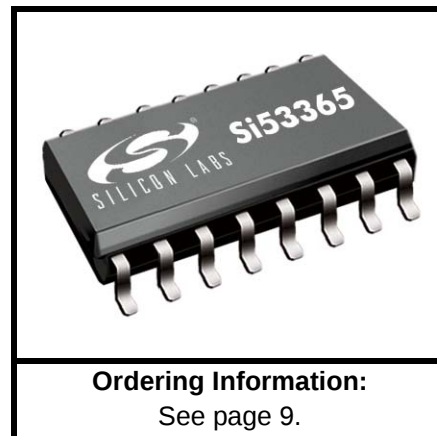
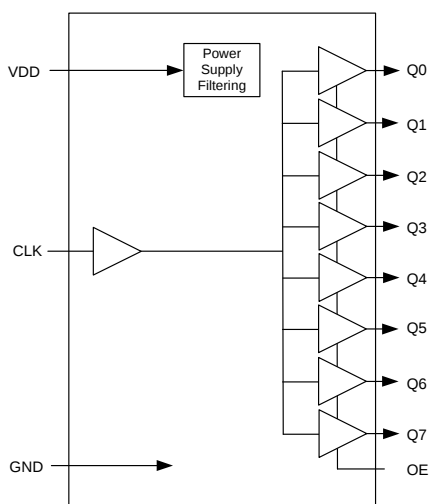
Applications

- High-speed clock distribution
- Ethernet switch/router
- Optical Transport Network (OTN)
- SONET/SDH
- PCI Express Gen 1/2/3
- Storage
- Telecom
- Industrial
- Servers
- Backplane clock distribution

Description

The Si53365 is an ultra low jitter eight output LVCMOS buffer. The Si53365 utilizes Silicon Laboratories' advanced CMOS technology to fanout clocks from 1 MHz to 200 MHz with guaranteed low additive jitter, low skew, and low propagation delay variability. The Si53365 supports operation over the industrial temperature range and can be operated from a 1.8 V, 2.5 V, or 3.3 V supply.

Functional Block Diagram



Patents pending

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1. Electrical Specifications

Table 1. Recommended Operating Conditions

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Ambient Operating Temperature	T_A		-40	—	85	°C
Supply Voltage Range	V_{DD}	LVCMOS	1.71	1.8	1.89	V
			2.38	2.5	2.63	V
			2.97	3.3	3.63	V

Table 2. DC Characteristics

($V_{DD} = 1.8\text{ V} \pm 5\%$, $2.5\text{ V} \pm 5\%$, or $3.3\text{ V} \pm 10\%$, $T_A = -40$ to $85\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Input Voltage High, CLK _n	V_{IH}		$V_{DD} \times 0.7$	—	—	V
Input Voltage Low, CLK _n	V_{IL}		—	—	$V_{DD} \times 0.3$	V
Input Voltage High (OE, CLK_SEL)	V_{IH}		$V_{DD} \times 0.7$	—	—	V
Input Voltage Low (OE, CLK_SEL)	V_{IL}		—	—	$V_{DD} \times 0.3$	V
Output Voltage High	V_{OH}	$I_{OH} = -\text{TBD mA}$	$V_{DD} \times 0.8$			V
Output Voltage Low	V_{OL}	$I_{OL} = \text{TBD mA}$			$V_{DD} \times 0.2$	V
Input Capacitance	C_{IN}		—	5	—	pF
Internal Pull up Resistor	R_{UP}	OE, CLK_SEL	—	25	—	k Ω
Leakage Current	I_L	Input leakage at all inputs except CLK _n , $V_{IN} = 0\text{ V}$	—	—	TBD	μA
		Input leakage at CLK _n , $V_{IN} = 0\text{ V}$	—	—	TBD	μA
Operating Supply Current	I_{DD}	3.3 V, LVCMOS, $C_L = 5\text{ pF}$, 200 MHz	—	TBD	220	mA

Table 3. AC Characteristics

($V_{DD} = 1.8\text{ V} \pm 5\%$, $2.5\text{ V} \pm 5\%$, or $3.3\text{ V} \pm 10\%$, $T_A = -40\text{ to }85\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Frequency	F	LVCMOS	1	—	200	MHz
Duty Cycle Note: 50% input duty cycle.	D_C	200 MHz, $50\ \Omega$ to $V_{DD}/2$, 20/80% $T_R/T_F < 10\%$ of period	45	—	55	%
Minimum Input Clock Slew Rate	SR	Required to meet prop delay and additive jitter specifications (20-80%)	0.75	—	—	V/ns
Output Rise/Fall Time	T_R/T_F	200 MHz, $50\ \Omega$, 20/80%, 2 pF load, 12 mA drive strength	—	—	750	ps
Minimum Input Pulse Width	T_W		500	—	—	ps
Additive Jitter	J	3.3 V, LVCMOS, 200 MHz, $V_{in} = 1.2\text{ V}_{PP}$	—	150	—	fs
Propagation Delay	T_{PLH} , T_{PHL}	Low to high, high to low Single-ended	TBD	—	TBD	ns
Output Enable Time	T_{EN}	F = 1 MHz	—	2	—	μs
		F = 100 MHz	—	60	—	ns
Output Disable Time	T_{DIS}	F = 1 MHz	—	2	—	μs
		F = 100 MHz	—	25	—	ns
Output to Output Skew	T_{SK}	Identical Configuration, Single-ended (Q_N to Q_M)	—	—	150	ps

Table 4. Thermal Conditions

Parameter	Symbol	Test Condition	Value	Unit
Thermal Resistance, Junction to Ambient	θ_{JA}	Still air	102.42	°C/W
Thermal Resistance, Junction to Case	θ_{JC}	Still air	32.62	°C/W

Table 5. Absolute Maximum Ratings

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Storage Temperature	T_S		–55	—	150	°C
Supply Voltage	VDD		–0.5	—	3.8	V
Input Voltage	V_{IN}		–0.5	—	VDD+0.3	V
Output Voltage	V_{OUT}		—	—	VDD+0.3	V
ESD Sensitivity	HBM	HBM, 100 pF, 1.5 kΩ	2000	—	—	V
ESD Sensitivity	CDM		500	—	—	V
Peak Soldering Reflow Temperature	T_{PEAK}	Pb-Free; Solder reflow profile per JEDEC J-STD-020	—	—	260	°C
Maximum Junction Temperature	T_J		—	—	125	°C
Note: Stresses beyond those listed in this table may cause permanent damage to the device. Functional operation specification compliance is not implied at these conditions. Exposure to maximum rating conditions for extended periods may affect device reliability.						

2. Functional Description

The Si53365 is a low jitter, low skew 1:8 CMOS buffer with asynchronous output enable. The Si53365 is ideal for low jitter LVCMOS clock distribution.

2.1. Input Termination

Figure 1 shows the recommended input clock termination.

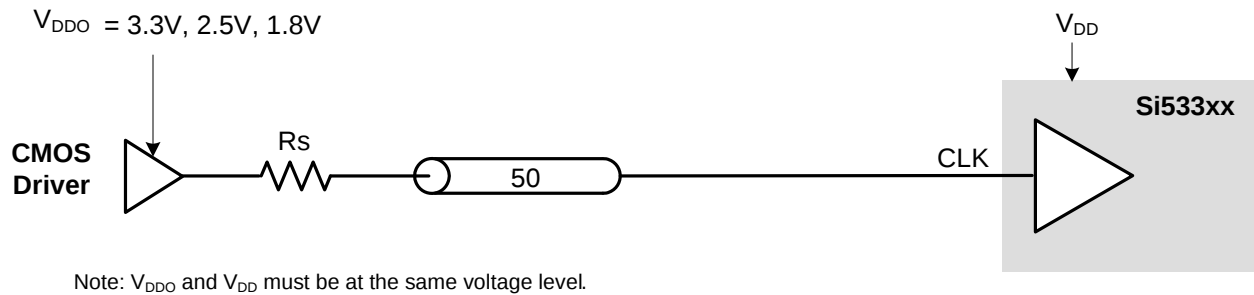


Figure 1. LVCMOS DC-Coupled Input Termination

2.2. Output Enable Logic

The table below summarizes the input and output clock state based on the output enable pin setting.

Table 6. Output Logic

INPUTS		OUTPUTS
CLK	OE	Qn
X	L	Tristate
L	H	L
H	H	H

2.3. Output Clock Termination Options

The recommended output clock termination options are shown below. Unused output clocks should be left floating.

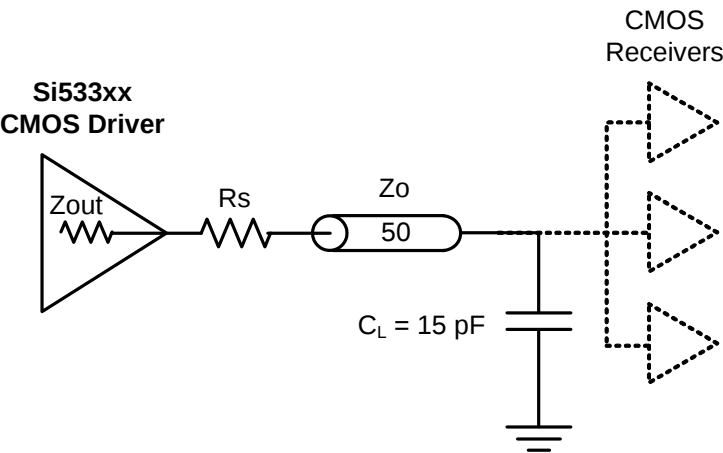


Figure 2. LVCMOS Output Termination

2.4. AC Timing Waveforms

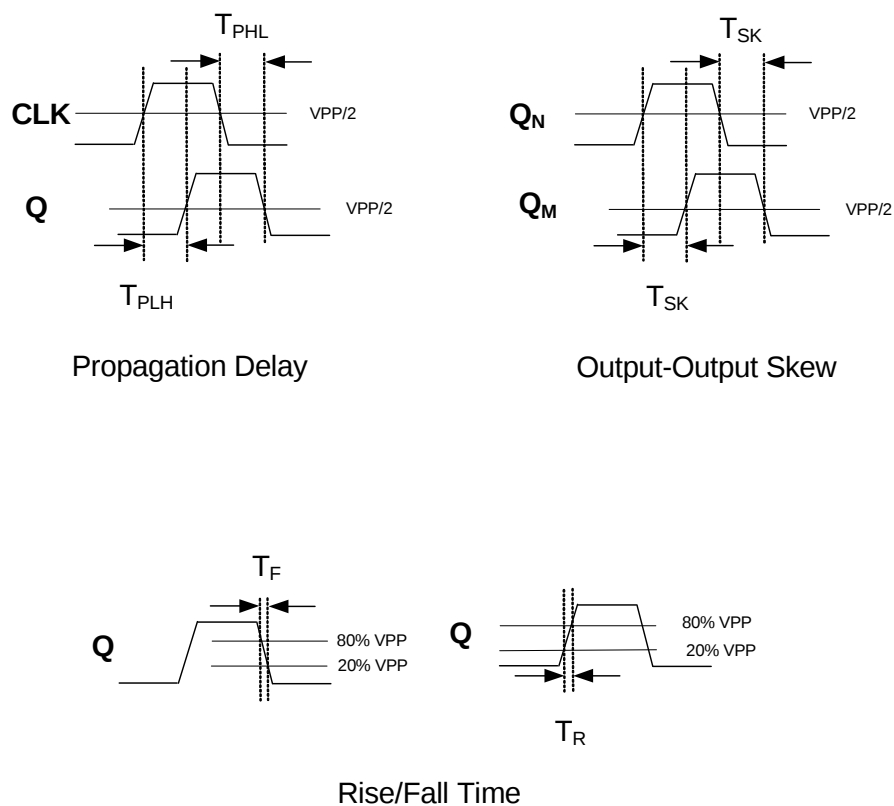


Figure 3. AC Waveforms

3. Pin Description: 16-Pin TSSOP

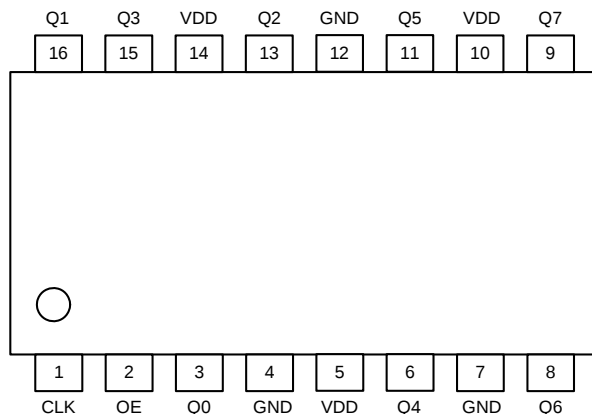


Table 7. Si53365 Pin Description

Pin #	Name	Description
1	CLK	Input clock.
2	OE	Output enable. When OE=high, the clock outputs are enabled. When OE=low, the clock outputs are tri-stated. OE contains an internal pull-up resistor.
3	Q0	Output clock 0.
4	GND	Ground.
5	V _{DD}	Core voltage supply. Bypass with 1.0 μ F capacitor and place as close to the V _{DD} pin as possible.
6	Q4	Output clock 4.
7	GND	Ground.
8	Q6	Output clock 6.
9	Q7	Output clock 7.
10	V _{DD}	Core voltage supply. Bypass with 1.0 μ F capacitor and place as close to the V _{DD} pin as possible.
11	Q5	Output clock 5.
12	GND	Ground.
13	Q2	Output clock 2.
14	V _{DD}	Core voltage supply. Bypass with 1.0 μ F capacitor and place as close to the V _{DD} pin as possible.
15	Q3	Output clock 3.
16	Q1	Output clock 1.

4. Ordering Guide

Part Number	Package	PB-Free, ROHS-6	Temperature
Si53365-B-GT	16-TSSOP	Yes	–40 to 85 °C

5. Package Outline

5.1. 16-TSSOP Package Diagram

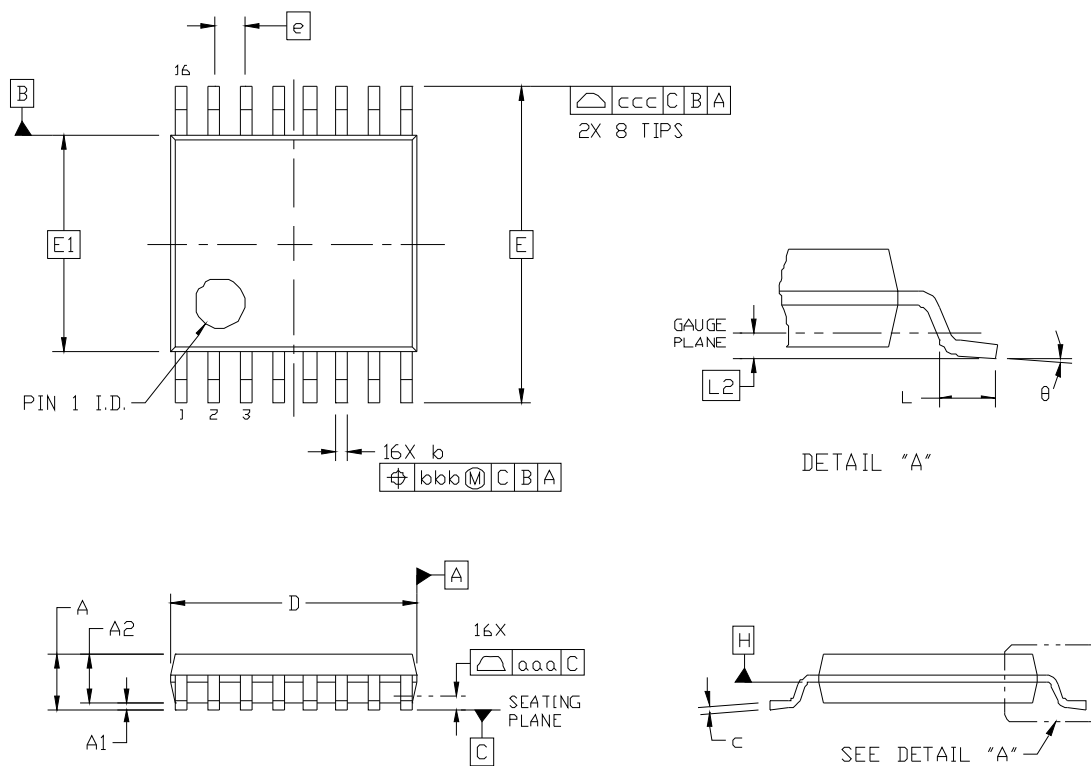


Figure 4. Si53365 16-TSSOP Package Diagram

Table 8. Package Dimensions

Dimension	Min	Nom	Max	Dimension	Min	Nom	Max
A	—	—	1.20	e	0.65 BSC		
A1	0.05	—	0.15	L	0.45	0.60	0.75
A2	0.80	1.00	1.05	L2	0.25 BSC		
b	0.19	—	0.30	θ	0°	—	8°
c	0.09	—	0.20	aaa	0.10		
D	4.90	5.00	5.10	bbb	0.10		
E	6.40 BSC			ccc	0.20		
E1	4.30	4.40	4.50				

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to the JEDEC Solid State Outline MO-153, Variation AB.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

6. PCB Land Pattern

6.1. 16-TSSOP Package Land Pattern

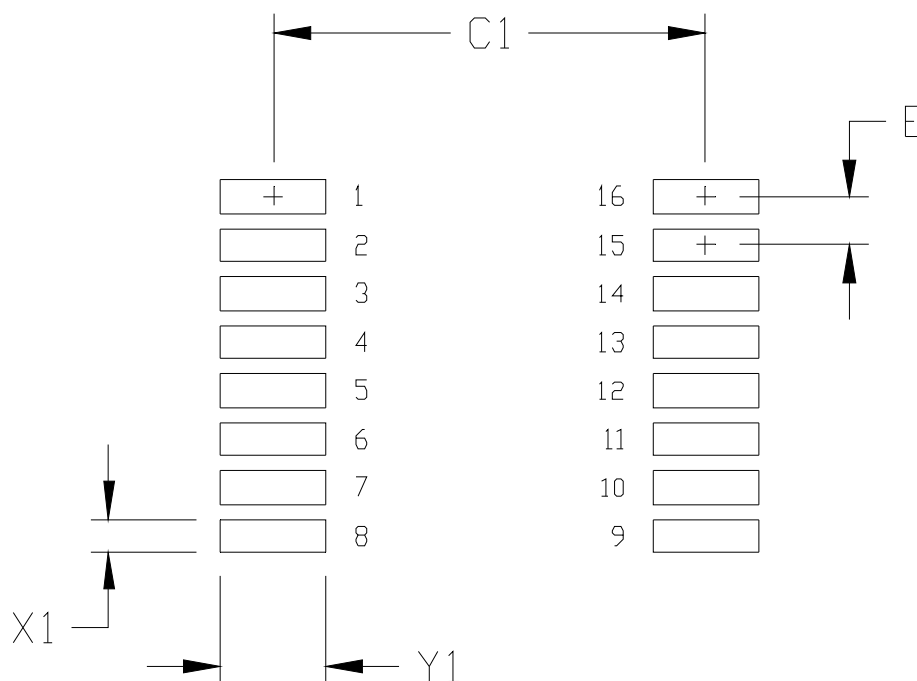


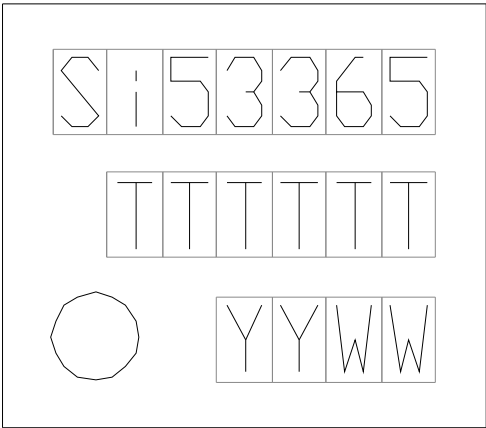
Figure 5. Si53365 16-TSSOP Package Land Pattern

Table 9. PCB Land Pattern

Dimension	Feature	(mm)
C1	Pad Column Spacing	5.80
E	Pad Row Pitch	0.65
X1	Pad Width	0.45
Y1	Pad Length	1.40
Notes: 1. This Land Pattern Design is based on the IPC-7351 guidelines. 2. All feature sizes shown are at Maximum Material Condition (MMC) and a card fabrication tolerance of 0.05 mm is assumed.		

7. Top Marking

7.1. Si53365 Top Marking



7.2. Top Marking Explanation

Mark Method:	Laser	
Font Size:	2.0 Point (0.71 mm) Right-Justified	
Line 1 Marking:	Customer Part Number	Si53365
Line 2 Marking:	TTTTTT = Mfg Code	Manufacturing Code from the Assembly Purchase Order form.
Line 3 Marking:	YY = Year WW = Work Week	Assigned by the Assembly House. Corresponds to the year and work week of the build date.

NOTES:

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